KAMAYA OHM

Spec. No.: RLC-K-HTS-0001 /16

Date: 2017. 1. 10

Specification

Title: FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE &

LOW OHM

Style: RLC10, 16, 20, 32, 35, 50, 63

RoHS COMPLIANCE ITEM
Halogen and Antimony Free

Product specification contained in this specification are subject to change at any time without notice If you have any questions or a Purchasing Specification for any quality Agreement is necessary, please contact our sales staff.



Hokkaido Research Center Approval by: T. Sannomiya Drawing by: M. Shibuya

Note: Stock conditions

Temperature: $+5^{\circ}$ C ~ $+35^{\circ}$ C Relative humidity: 25% ~ 75%

The period of guarantee: Within 2 year from shipmen t by the company.

Solderability shall be satisfied.

Drawing No: RLC-K-HTS-0001

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Title: FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE AND LOW OHM

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1. Scope

1.1 This specification covers the detail requirements for fixed thick film chip resistors; rectangular type and low ohm, style of RLC10, 16, 20, 32, 35, 50, 63.

1.2 Applicable documents

JIS C 5201–1: 2011, JIS C 5201–8: 2014, JIS C 5201–8–1: 2014 IEC60115–1: 2008, IEC60115–8: 2009, IEC60115–8–1: 2014 EIAJ RC-2144-2010

2. Classification

Type designation shall be the following form.

1 Fixed thick film chip resistors; rectangular type and low ohm



2 Size

3 Temperature coefficient of resistance

K	±100×10 ⁻⁶ /°C
-(Dash)	Standard
L	See Paragraph 3.2

4 Rated resistance Rated resistance and symbol shall be in accordance with Sub-clause 3.3.

5 Tolerance on rated resistance

F	±1%
G	±2%
J	±5%

6 Packaging form

В	Bulk (loose package)	
TH	Donostonios	
TP	Paper taping	
TE	Embossed taping	

Title: FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE AND LOW OHM

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3. Rating

The ratings shall be in accordance with Table-1.

3.1 Temperature coefficient of resistance: K & -(Dash) code

Table-1(1)

Style	Rated dissipation (W)	Rated current range (A)	Temperature coefficient of resistance (10 ⁻⁶ / °C)		Rated resistance range(Ω)	Tolerance on rated resistance					
			K	±100	3.6~10	F(±1%), J(±5%)					
RLC10	0.125	0.11~1.11	(Dook)	0~+200	0.47~3.3	F(±1%), G(±2%), J(±5%)					
			-(Dash)	0~+300	0.1~0.43	F(±1%), J(±5%)					
			K	1.400	3.6~10	F(±1%), J(±5%)					
RLC16	0.25	044 4 50	N.	±100	0.47~3.3	F(±1%)					
KLC16	0.25	0.14~1.58	(Deeb)	0~+200	0.2~0.43	G(±2%)					
			-(Dash)	0~+250	0.1~0.18	J(±5%)					
			K	±100	3.6~10	F(±1%), J(±5%)					
RLC20	0.33	0.45 0.56	K	± 100	0.47~3.3	F(±1%)					
NLC20	0.55	0.15~2.56	-(Dash)	0~+200	0.2~0.43	G(±2%)					
			-(Dasii)	0~+250	0.05~0.18	J(±5%)					
			K	±100	3.6~10	F(±1%), J(±5%)					
RLC32	0.5	0.18~3.16	0.18~3.16	0.18~3.16	0.18~3.16	0.10.216	0.10.216	K	± 100	0.47~3.3	F(±1%)
KLC32	0.5					-(Dash)	0~+200	0.2~0.43	G(±2%)		
			-(Dasii)	0~+250	0.05~0.18	J(±5%)					
			K	±100	0.47~3.3	F(±1%)					
RLC35	0.66	0.44~3.63	-(Dash)	0~+200	0.2~0.43	G(±2%)					
			-(Da5H)	0~+250	0.05~0.18	J(±5%)					
			K	±100	0.47~3.3	F(±1%)					
RLC50	0.75	0.47~3.87	-(Dash)	0~+200	0.2~0.43	G(±2%)					
			-(Dasii)	0~+250	0.05~0.18	J(±5%)					
			K	±100	0.47~3.3	F(±1%)					
RLC63	1.0	0.55~4.47	-(Dash)	0~+200	0.2~0.43	G(±2%)					
			¬(Dasii)	0~+250	0.05~0.18	J(±5%)					

Style	Limiting element	Isolation voltage	Category temperature
Style	voltage(V)	(V)	range (°C)
RLC10	1.11	100	
RLC16	1.41	100	
RLC20	1.58		
RLC32	1.81		-55~+155
RLC35	1.47	500	
RLC50	1.56		
RLC63	1.82		

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3.2 Temperature coefficient of resistance: L code

Table-1(2)

Style	Rated dissipation (W)	Rated current range (A)	Temperature coefficient of resistance (10 ⁻⁶ / °C)		Rated resistance range(Ω)	Tolerance on rated resistance																							
	, ,	U , ,		±300	0.51~0.91																								
RLC10	0.063	0.26~1.12	L	±800	0.10~0.50	F(±1%), J(±5%)																							
				±1500	0.05~0.091																								
				±300	0.51~0.91																								
RLC16	0.1	0.22.2.16	L	±800	0.10~0.50	□ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □																							
KLC10	0.1	0.33~3.16	0.33~3.10	L	±1200	0.039~0.091	F(±1%), J(±5%)																						
				±2000	0.01~0.036																								
				±200	0.51~0.91																								
				±300	0.39~0.50																								
RLC20	0.25	0.50.5.0	L	±600	0.10~0.36	□ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □																							
KLC20	0.25	0.52~5.0	L	±1000	0.05~0.091	F(±1%), J(±5%)																							
				±1200	0.02~0.047																								
				±1500	0.01~0.018																								
						±200	0.51~0.91																						
				±300	0.39~0.50																								
DI 000	0.5	0.74~7.07	L	±600	0.10~0.36	F(±1%), J(±5%)																							
RLC32	0.5			±1000	0.05~0.091																								
				±1200	0.02~0.047																								
				±1500	0.01~0.018																								
		0.85~8.12							±200	0.51~0.91																			
							±300	0.39~0.50																					
RLC35				±600	0.10~0.36	F(±1%), J(±5%)																							
RLC33	0.66		L	±1000	0.05~0.091																								
				±1200	0.02~0.047																								
																												±1500	0.01~0.018
				±200	0.51~0.91																								
				±300	0.39~0.50																								
RLC50	0.75	0.00 0.66	L	±600	0.10~0.36	E/±10/\																							
KLC30	0.75	0.90~8.66	L	±1000	0.05~0.091	F(±1%), J(±5%)																							
				±1200	0.02~0.047																								
			±1500	0.01~0.018																									
				±200	0.51~0.91																								
				±300	0.39~0.50																								
DI 000	1.0	10 10110	1.04~10 L	±600	0.10~0.36	Γ/±40/\																							
RLC63	1.0	1.04~10		±1000	0.05~0.091	F(±1%), J(±5%)																							
				±1200	0.02~0.047																								
			±1500	0.01~0.018																									

Style	Limiting element voltage (V)	Isolation voltage (V)	Category temperature range (°C)
RLC10	0.23	100	
RLC16	0.30	100	
RLC20	0.47		
RLC32	0.67		<i>–</i> 55~+155
RLC35	0.77	500	
RLC50	0.82		
RLC63	0.95		

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3.3 Rated resistance

The rated resistance shall be in accordance with Table-2

Table-2

		iabie-2			
Rated resistance	e	Rated resistance	e	Rated resistand	æ
Rated resistance [m Ω]	Symbol	Rated resistance [m Ω]	Symbol	Rated resistance $[\Omega]$	Symbol
10	R010	100	R100	1.0	1R00
11	R011	110	R110	1.1	1R10
12	R012	120	R120	1.2	1R20
13	R013	130	R130	1.3	1R30
15	R015	150	R150	1.5	1R50
16	R016	160	R160	1.6	1R60
18	R018	180	R180	1.8	1R80
20	R020	200	R200	2.0	2R00
22	R022	220	R220	2.2	2R20
24	R024	240	R240	2.4	2R40
25	R025	250	R250	2.7	2R70
27	R027	270	R270	3.0	3R00
30	R030	300	R300	3.3	3R30
33	R033	330	R330	3.6	3R60
36	R036	360	R360	3.9	3R90
39	R039	390	R390	4.3	4R30
40	R040	400	R400	4.7	4R70
43	R043	430	R430	5.1	5R10
47	R047	470	R470	5.6	5R60
50	R050	500	R500	6.2	6R20
51	R051	510	R510	6.8	6R80
56	R056	560	R560	7.5	7R50
60	R060	600	R600	8.2	8R20
62	R062	620	R620	9.1	9R10
65	R065	650	R650	10	100
68	R068	680	R680		
70	R070	700	R700		
75	R075	750	R750		
80	R080	800	R800		
82	R082	820	R820		
90	R090	900	R900		
91	R091	910	R910		

3.4 Climatic category

55/155/56 Lower category temperature $-55\,^{\circ}\text{C}$ Upper category temperature $+155\,^{\circ}\text{C}$ Duration of the damp heat, steady state test 56days

3.5 Stability class

5% Limits for change of resistance:

-for long–term tests $\pm 5\%$ -for short–term tests $\pm 1\%$

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3.6 Derating

The derated values of dissipation at temperature in excess of 70 °C shall be as indicated by the following curve.

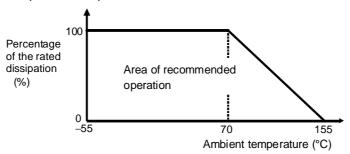


Figure-1 Derating curve

3.7 Rated voltage

d.c. or a.c. r.m.s. voltage calculated from the square root of the product of the rated resistance and the rated dissipation.

$$E = \sqrt{P \cdot R}$$

E: Rated voltage (V)

P: Rated dissipation (W)

R: Rated resistance (Ω)

Limiting element voltage can only be applied to resistors when the resistance value is equal to or higher than the critical resistance value.

At high value of resistance, the rated voltage may not be applicable.

3.8 Rated current

The rated current calculated from the square root of the quotient of the rated resistance and the rated dissipation.

$$I = \sqrt{P / R}$$

I: Rated current (A)

P: Rated dissipation (W)

R: Rated resistance (Ω)

The rated current shall be corresponding to rated voltage.

4. Packaging form

The standard packaging form shall be in accordance with Table-3.

Table_3

		101	0.0	
Symbol	I	Packaging form	Standard packaging quantity / units	Application
В	Bulk (loose pack	age)	1,000 pcs.	RLC10, 16, 20, 32, 35, 50, 63
TH	Paper taping	8mm width, 2mm pitches	10,000 pcs.	RLC10
TP	Paper taping 8mm width, 4mm pitches		5,000 pcs.	RLC16, 20, 32
TE	Embossed	8mm width, 4mm pitches	4 000 pee	RLC35
'-	taping 12mm width, 4mm pitches		4,000 pcs.	RLC50, 63

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5. Dimensions

5.1 The resistor shall be of the design and physical dimensions in accordance with Figure-2 and Table-4.

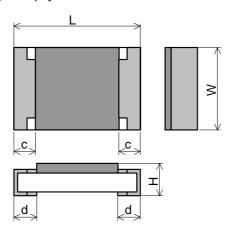


Figure-2

5.1.1 Temperature coefficient of resistance: K & -(Dash) code

		Table-4(1)			Unit: mm
Style	L	W	Н	С	d
RLC10	1.0 ± 0.05	0.5 ± 0.05	0.35 ± 0.05	0.2 ± 0.1	$0.25^{+0.05}_{-0.10}$
RLC16	1.6±0.1	0.8 +0.15	0.45±0.1	0.3±0.1	0.3±0.1
RLC20	2.0±0.1	1.25±0.10	0.6±0.1	0.4±0.2	0.4±0.2
RLC32	3.1±0.2	1.6±0.15	0.6±0.1	0.5±0.25	0.3 +0.2 -0.1
RLC35	3.1±0.2	2.5±0.15	0.6±0.15	0.5±0.25	0.3 +0.2 -0.1
RLC50	5.0±0.2	2.5±0.15	0.6±0.15	0.6±0.2	0.6±0.2
RLC63	6.3±0.2	3.2±0.15	0.6±0.15	0.6±0.2	0.6±0.2

5.1.2 Temperature coefficient of resistance: L code

		Table-4(2)			Unit: mm
Style	L	W	Н	С	d
RLC10	1.0±0.05	0.5±0.05	0.35±0.05	0.2±0.1	$0.25^{+0.05}_{-0.10}$
RLC16	1.6±0.1	0.8±0.1	0.45±0.15	0.3±0.1	0.3±0.2
RLC20	2.0±0.1	1.25±0.10	0.5±0.15	0.4±0.2	0.4±0.2
RLC32	3.1±0.1	1.6±0.1	0.6±0.15	0.5±0.2	0.45±0.20
RLC35	3.1±0.1	2.6±0.1	0.55±0.10	0.5±0.2	0.5±0.2
RLC50	5.0±0.2	2.5±0.2	0.55±0.10	0.65±0.25	0.6±0.25
RLC63	6.4±0.2	3.2±0.2	0.6±0.1	0.65±0.25	0.9±0.25

5.2 Net weight (Reference)

3 \ ,			
Style	Net weight (mg)		
RLC10	0.6		
RLC16	2		
RLC20	5		
RLC32	9		
RLC35	16		
RLC50	25		
RLC63	40		

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6. Marking

The rated resistance of RLC10 should not be marked.

6.1 RLC20,32,35,50,63

The rated resistance shall be marked in 4 characters consisting of 3 figures or 3 figures and a letter and marked on over coat side.

(Example) "R050"
$$\rightarrow$$
 0.05 [Ω] (R<1 Ω) "100" \rightarrow 10 [Ω] (R \geq 1 Ω)

6.2 RLC16 (L code only)

The nominal resistance shall be marked in 3 digits (E24 and/or E96) and marked on over coat side.

•100m Ω ~910m Ω , E24 series: "R" followed by 2 significant digits if the 4th digit is "0"

(Example) "R22"
$$\rightarrow$$
 220 [m Ω] \rightarrow 0.22 [Ω]

•100m Ω -976m Ω , E96 series: The 1st two digit codes are referring to the code on the table, the 3rd code is the index of resistance value: "Z"(10⁻³)

$$\begin{array}{cccc} \text{(Example)} & \text{``25Z''} & \rightarrow & 178 \, [\text{m}\Omega] & \rightarrow & 0.178 [\Omega] \\ & \text{``34Z''} & \rightarrow & 221 \, [\text{m}\Omega] & \rightarrow & 0.221 [\Omega] \\ \end{array}$$

•1m Ω ~99m Ω : The 3rd code is the index of resistance value: "M".

"M" = "m", means1/1000

(Example) "75M" \rightarrow 75 [m Ω] \rightarrow 0.075[Ω]

6.2.1 Symbol for E96 series of resistance value

i Symbolic	JI E30 3011	CO OI ICOIO	tai icc valu	•					
E96	Symbol	E96	Symbol	E96	Symbol	E96	Symbol	E96	Symbol
100	01	162	21	261	41	422	61	681	81
102	02	165	22	267	42	432	62	698	82
105	03	169	23	274	43	442	63	715	83
107	04	174	24	280	44	453	64	732	84
110	05	178	25	287	45	464	65	750	85
113	06	182	26	294	46	475	66	768	86
115	07	187	27	301	47	487	67	787	87
118	08	191	28	309	48	499	68	806	88
121	09	196	29	316	49	511	69	825	89
124	10	200	30	324	50	523	70	845	90
127	11	205	31	332	51	536	71	866	91
130	12	210	32	340	52	549	72	887	92
133	13	215	33	348	53	562	73	909	93
137	14	221	34	357	54	576	74	931	94
140	15	226	35	365	55	590	75	953	95
143	16	232	36	374	56	604	76	976	96
147	17	237	37	388	57	619	77		
150	18	243	38	392	58	634	78		
154	19	249	39	402	59	649	79		
158	20	255	40	412	60	665	80		

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7. Performance

7.1 The standard condition for tests shall be in accordance with Sub-clause 4.2, JIS C 5201-1: 2011

7.2 The performance shall be satisfied in Table-5.

Table-5(1)

	,	1able- 5(1)	
No.	Test items	Condition of test (JIS C 5201–1)	Performance requirements
1	Visual examination	Sub-clause 4.4.1	As in 4.4.1
		Checked by visual examination.	The marking shall be legible, as
			checked by visual examination.
2	Dimension	Sub-clause 4.4.2	As specified in Table-4 of this
	Desista de la		specification.
	Resistance	Sub-clause 4.5	As in 4.5.2
		Measurement current: 10(mA)	The resistance value shall correspond
		Note: The measuring apparatus	with the rated resistance taking into
		corresponding to Digital multimeter of TR6878 for Advantest Corp	account the specified tolerance.
3	Voltage proof	Sub-clause 4.7	
3	Voltage proof	Method: 4.6.1.4(See Figure–5)	No breakdown or flash over
		Test voltage: Alternating voltage with a peak	THO DICARGOWITOT HAGIT OVER
		value of 1.42 times the insulation voltage.	
		Duration: 60 s±5 s	
		Insulation resistance	
		Test voltage: Insulation voltage	R≥1GΩ
		Duration: 1 min.	
4	Solderability	Sub-clause 4.17	As in 4.17.4.5
		Without aging	The terminations shall be covered with
		Flux: The resistors shall be immersed in a	a smooth and bright solder coating.
		non-activated soldering flux for 2 s.	
		Bath temperature: 235 °C±5 °C	
		Immersion time: 2 s±0.5 s	
5	Mounting	Sub-clause 4.31	
		Substrate material: Epoxide woven glass	
	Overload	Test substrate: Figure–3	
	(in the mounted state)	Sub-clause 4.13 The applied voltage shall be 2.5 times the	
	(2.12 1110011100 00010)	rated voltage or the current corresponding to.	
		Duration: 2 s	
		Visual examination	No visible damage
		Resistance	ΔR ≤ ±1%
	Solvent resistance of the	Sub-clause 4.30	Legible marking
	marking	Solvent: 2-propanol	
		Solvent temperature: 23 °C±5 °C	
		Method 1	
		Rubbing material: cotton wool	
		Without recovery	

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Table-5(2)

No	Test items	Condition of test (JIS C 5201–1)	Performance requirements
6	Mounting	Sub-clause 4.31	1 chomanec requirements
0	IVIOUTILITY		
		Substrate material: Epoxide woven glass	
	Bound strength of the end	Test substrate: Figure–4	
		Sub-clause 4.33	
	face plating	Bent value: 3 mm (3225 size max.)	
		1 mm (5025 size min.)	ΔR ≤ ±1%
	Final measurements	Resistance	ΔR ≤ ±1%
	Final measurements	Sub-clause 4.33.6	No visible demage
		Visual examination	No visible damage
7	Resistance to soldering heat	Sub-clause 4.18 (JEITA RC-2144 2.3.2)	
		T ₁ :Pre-heat minimum temp.:150±5 °C	
		T ₂ :Pre-heat maximum temp.:180±5 °C	
		T ₃ :Soldering temp.:220 °C	
		T ₄ :Peak temp.:250 °C	
		t₁:Pre-heat duration:120±5 s	
		t₂:Soldering duration:60 to 90 s	
		t_3 :Peak duration(T_4 -5°C):20 to 40 s	
		Pre-reflow soldering: 1 time	
		(Initial measurements)	
		Reflow soldering: 3 times	
		_	
		T ₄	
		T ₃	
		$\downarrow \qquad \qquad \downarrow \qquad \downarrow$	
		T ₂	
		T ₁ - t.	
		 	
		/	
		Visual examination	No visible damage
	Component solvent		$\Delta R \le \pm 1\%$
	resistance	Sub-clause 4.29	
		Solvent: 2-propanol	
		Solvent temperature: 23 °C±5 °C	
		Method 2	
		Recovery: 48 h	
		Visual examination	No visible damage
		Resistance	$\Delta R \le \pm 1\%$
		1/699191016	△I \

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Table-5(3)

A I	T	0 10 (1000 ==== 1)	Danfarra
No	Test items	Condition of test (JIS C 5201–1)	Performance requirements
8	Mounting	Sub-clause 4.31	
		Substrate material: Epoxide woven glass	
		Test substrate: Figure–3	
	Adhesion	Sub-clause 4.32	
		Force: 5 N	
		Duration: 10 s±1 s	
		Visual examination	
	Rapid change temperature	Sub-clause 4.19	No visible damage
		Lower category temperature:	
		_55 °C	
		Upper category temperature:	
		+155 °C	
		Duration of exposure at each temperature: 30	
		min.	
		Number of cycles: 5 cycles.	Nie Salie de cens
		Visual examination	No visible damage
		Resistance	$\Delta R \le \pm 1\%$
9	Climatic sequence	Sub-clause 4.23	
	-Dry heat	Sub-clause 4.23.2	
		Test temperature: +155 °C	
		Duration: 16 h	
	–Damp heat, cycle	Sub-clause 4.23.3	
	(12+12hour cycle)	Test method: 2	
	First cycle	Test temperature: 55 °C	
	,	[Severity(2)]	
	-Cold	Sub-clause 4.23.4	
		Test temperature –55 °C	
		Duration: 2h	
	-Damp heat, cycle	Sub-clause 4.23.6	
	(12+12hour cycle)	Test method: 2	
	Remaining cycle	Test temperature: 55 °C	
		[Severity (2)]	
		Number of cycles: 5 cycles	
	–D.C. load	Sub-clause 4.23.7	
		The applied current shall be the rated current.	
		Duration: 1 min.	No vicible demage
		Visual examination	No visible damage
		Resistance	ΔR ≤ ±5 %
10	Mounting	Sub-clause 4.31	
		Substrate material: Epoxide woven glass	
		Test substrate: Figure–3	
	Endurance at 70 °C	Sub-clause 4.25.1	
		Ambient temperature: 70 °C±2 °C	
		Duration: 1000 h	
		The current shall be applied in cycles of 1.5 h	
		on and 0.5 h.	
		The applied current shall be the rated current	
		Examination at 48 h, 500 h and	
		1000 h:	
		Visual examination	No visible damage
		Resistance	ΔR ≤ ±5 %

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FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE AND LOW OHM

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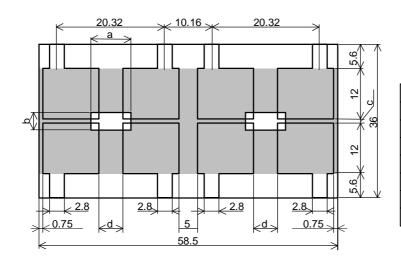
Table-5(4)

No	Test items	Condition of test (JIS C 5201–1)	Performance requirements
11	Mounting Variation of resistance with temperature	Sub-clause 4.31 Substrate material: Epoxide woven glass Test substrate: Figure–3 Sub-clause 4.8 +20 °C /+155 °C	As in Table–1
12	Mounting Damp heat, steady state	Sub-clause 4.31 Substrate material: Epoxide woven glass Test substrate: Figure–3 Sub-clause 4.24 Ambient temperature: 40 °C±2 °C Relative humidity: 93 ½ % Without current applied. Visual examination	No visible damage Legible marking
13	Dimensions (detail)	Resistance Sub-clause 4.4.3	ΔR ≤ ±5% As in Table–4
	Mounting Endurance at upper category temperature	Sub-clause 4.4.3 Sub-clause 4.31 Substrate material: Epoxide woven glass Test substrate: Figure–3 Sub-clause 4.25.3 Ambient temperature:155 °C±2 °C Duration: 1000 h Examination at 48 h, 500 h and 1000 h: Visual examination Resistance	No visible damage ΔR ≤ ±5%

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8. Test substrate

*1 Temperature coefficient of resistance: K & -(Dash) code

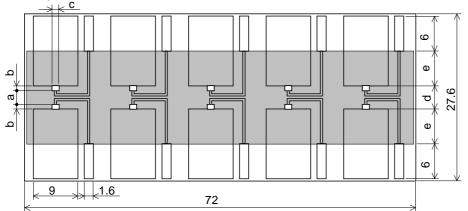


:Copper clad :Solder resist :Style a b c RLC10 1.9 0.7 0.16

Unit: mm

Style	а	b	С	d
RLC10	1.9	0.7	0.16	0.6
RLC16	3.0	1.2	0.16	1.0
RLC20	4.0	1.65	0.4	1.2
RLC32	5.0	2.0	0.5	2.2
RLC35	5.0	2.9	0.5	2.2
RLC50	7.5	3.0	0.8	4.0
RLC63	9.0	4.0	0.8	5.0

*2 Temperature coefficient of resistance: L code



:Copper clad
:Solder resist

Unit: mm

Style	а	b	С	d	е
RLC10	0.6	0.5	0.7	1.6	6.5
RLC16	1.0	0.6	0.8	2.2	6.2
RLC20	1.3	0.7	1.25	2.7	5.95
RLC32	2.1	0.9	1.7	3.9	5.35
RLC35	2.2	1.4	2.9	5.0	4.8
RLC50	3.76	1.12	2.8	6.0	4.3
RLC63	4.0	1.8	3.5	7.6	3.5

Figure-3 RLC TEST SUBSTRATE

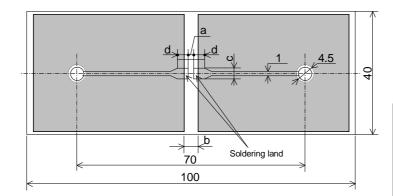
Remark 1). Material: Epoxide woven glass

Thickness: 1.6mm Thickness of copper clad: 0.035mm

2). In the case of connection by connector, the connecting terminals are gold plated. However, the plating is not necessary when the connection is made by soldering.

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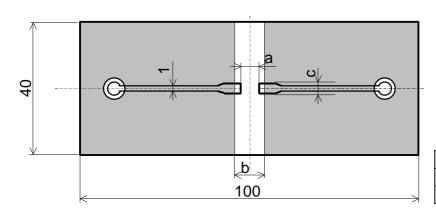
*1 Temperature coefficient of resistance: K & -(Dash) code

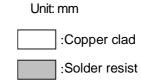


Unit: mm			
	:Copper clad		
	Solder resist		

Style	а	b	С	d
RLC10	0.6	1.9	0.7	2.0
RLC16	1.0	3.6	1.2	3.0
RLC20	1.2	4.0	1.65	3.0
RLC32	2.5	5.0	2.0	2.5
RLC35	2.2	5.0	2.9	2.5

RLC10,16, 20, 32, 35 BOUND STRENGTH OF THE END FACE PLATING TEST SUBSTRATE

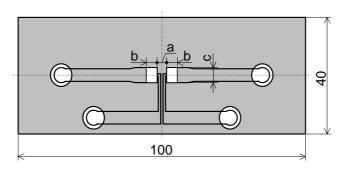




Style	а	b	С
RLC50	4.0	7.5	3.0
RLC63	5.0	9.0	4.0

RLC50, 63 BOUND STRENGTH OF THE END FACE PLATING TEST SUBSTRATE

*2 Temperature coefficient of resistance: L code



Unit: mm				
	:Copper clad			
	:Solder resist			

Style	а	b	С
RLC10	0.6	0.5	0.7
RLC16	1.0	0.6	0.8
RLC20	1.3	0.7	1.25
RLC32	2.1	0.9	1.7
RLC35	2.2	1.4	2.9
RLC50	3.76	1.12	2.8
RLC63	4.0	1.8	3.5

Remark 1). Material: Epoxide woven glass

Thickness: 1.6mm Thickness of copper clad: 0.035mm

Figure-4 RLC BOUND STRENGTH OF THE END FACE PLATING TEST SUBSTRATE

KAMAYA OHM

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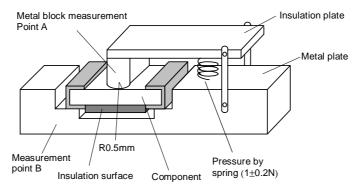


Figure-5

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9. Taping

- 9.1 Applicable documents JIS C 0806–3: 2014, EIAJ ET–7200C: 2010
- 9.2 Taping dimensions
- 9.2.1 Paper taping (8mm width, 2mm pitches)

Taping dimensions shall be in accordance with Figure-6 and Table-6.

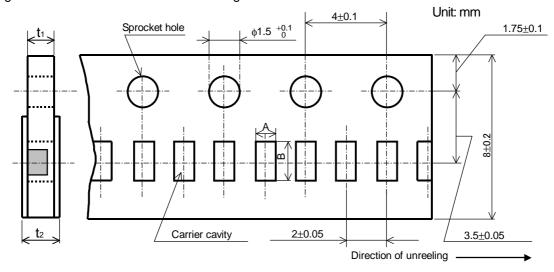


 Figure-6

 Table-6
 Unit: mm

 Style
 A
 B
 t_1 t_2

 RLC10
 $0.65^{+0.05}_{-0.10}$ $1.15^{+0.05}_{-0.10}$ 0.4 ± 0.05 0.5max.

9.2.2 Paper taping (8mm width, 4mm pitches)

Taping dimensions shall be in accordance with Figure-7 and Table-7.

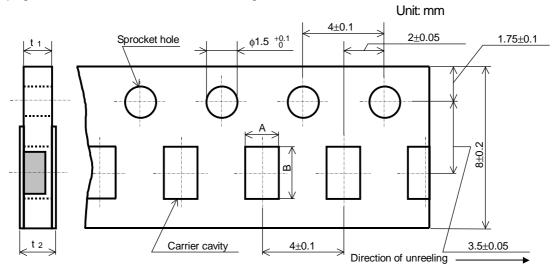


Figure-7 Table-7 Unit: mm Style t₁ t 2 RLC16 1.9 ± 0.2 1.15±0.15 0.6 ± 0.1 0.8max. RLC20 1.65±0.15 2.5 ± 0.2 0.8 ± 0.1 1.0max. RLC32 2.00±0.15 3.6 ± 0.2

RLC10, 16, 20, 32, 35, 50, 63 Page: 16/17

9.2.3 Embossed taping dimensions shall be in accordance with Figure-8 and Table-8.

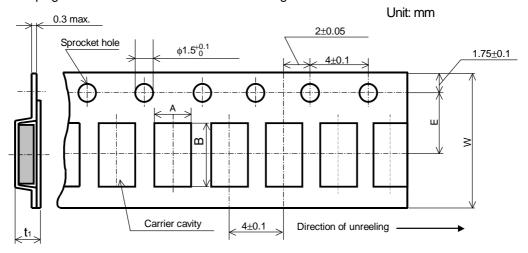
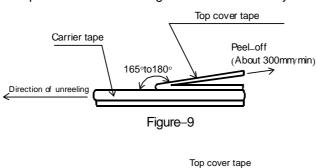
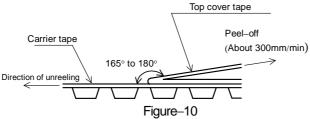


Figure-8 Table-8 Unit: mm Α В W Ε Style t₁ RLC35 3.5±0.05 2.85±0.2 3.5 ± 0.2 8±0.3 1.0±0.2 RLC50 3.1±0.2 5.5±0.2 12±0.3 5.5±0.05 1.1±0.15 RLC63 3.6 ± 0.2 6.9 ± 0.2

- 1). The cover tapes shall not cover the sprocket holes.
- 2). Tapes in adjacent layers shall not stick together in the packing.
- 3). Components shall not stick to the carrier tape or to the cover tape.
- 4). Pitch tolerance over any 10 pitches ±0.2mm.
- 5). The peel strength of the top cover tape shall be with in 0.1N to 0.5N on the test method as shown in the following RLC10, 16, 20, 32: Figure–9, RLC35, 50, 63: Figure–10.
- 6). When the tape is bent with the minimum radius for (RLC10, 16, 20, 32, 35: 25mm, RLC50, 63: 30mm) the tape shall not be damaged and the components shall maintain their position and orientation in the tape.
- 7). In no case shall there be two or more consecutive components missing.

 The maximum number of missing components shall be one or 0.1%, whichever is greater.
- 8). The resistors shall be faced to upward at the over coating side in the carrier cavity.



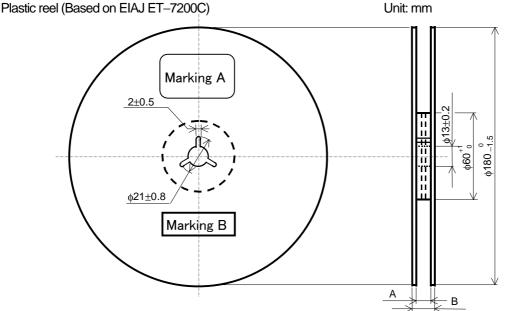


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9.3 Reel dimension

Reel dimensions shall be in accordance with the following Figure–11 and Table–9.



Figure–11

	Table-9		Unit: mm
	А	В	Note
9 +1.0	11.4±1.0	Injection molding	
	13±1.0	Vacuum forming	
	13 +1.0	17+1 0	Vacuum forming

Note: Marking label shall be marked on a place of Marking A or two place of marking A and B.

9.4 Leader and trailer tape.

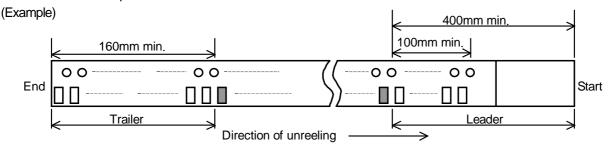


Figure-12

10. Marking on package

The label of a minimum package shall be legibly marked with follows.

Style RLC10, 16, 20, 32, 35 RLC50, 63

10.1 Marking A

(1) Classification

(Style, Temperature coefficient of resistance, Rated resistance, Tolerance on rated resistance, Packaging form)

(2) Quantity (3) Lot number (4) Manufacturer's name or trade mark (5) Others 10.2 Marking B (KAMAYA control label)